

CHIP 100 WATT TERMINATION

DATA SHEET PART NUMBER: CT2335H SHEET 1 OF 1 EN 13-0721 03/27/2013

FEATURES

DC – 8.0 GHz 100 Watt BeO Substrate Low VSWR

APPLICATIONS

Mobile Networks Broadcast High Power Amplifiers Instrumentation Isolators Military

Satellite Communications



GENERAL DESCRIPTION

EMC Technology's terminations are designed for direct installation on printed circuit boards and manufactured using thick film technology. Edge metallization form the solder fillets for stronger attachment, easier inspection and increased heat removal area. The devices are available in Alumina, Aluminum Nitride or Beryllium Oxide.

SPECIFICATIONS

1.0 ELECTRICAL

Nominal Impedance: 50 Ω

Frequency Range: DC − 8.0 GHz
VSWR: 1.25:1 Max
Temperature Coefficient: ± 200 PPM/℃ Max

Power Rating: 100 Watts

Operating Temperature: -55 ℃ To +125 ℃

DC Resistance: $50 \Omega \pm 2\%$

2.0 MECHANICAL

Substrate Beryllium Oxide
Resistive Film: Thick Film
Metallization: Thick Film

3.0 UNIT MARKING

None

4.0 PACKAGING

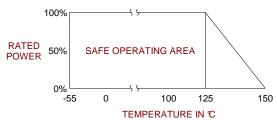
Standard: Tape and Reel

Optional: Available Upon Request

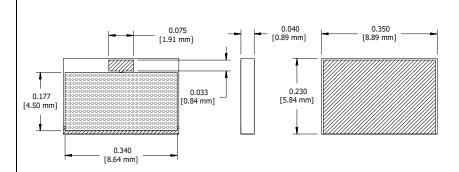
5.0 PART NUMBERING

Part Identifier: CT2335H

POWER RATING AND DERATING



MECHANICAL OUTLINE



Note: Specifications are subject to change without notice.

TOLERANCE: ±.010

